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Vishay Siliconix

Automotive P-Channel 12 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	- 12			
$R_{DS(on)}$ (Ω) at $V_{GS} = -4.5 \text{ V}$	0.0060			
$R_{DS(on)}$ (Ω) at $V_{GS} = -2.5 \text{ V}$	0.0080			
I _D (A)	- 32			
Configuration	Single			

FEATURES

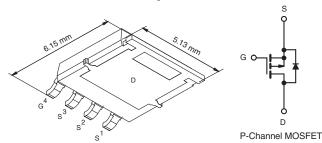
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- AEC-Q101 Qualifiedd
- 100 % Rq and UIS Tested
- Compliant to RoHS Directive 2002/95/EC







PowerPAK® SO-8L Single



ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and Halogen-free	SQJ401EP-T1-GE3

ABSOLUTE MAXIMUM RATING	S (T _C = 25 °C, unles	ss otherwise noted)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	- 12	V
Gate-Source Voltage		V_{GS}	± 8	V
Continuous Drain Currenta	T _C = 25 °C	1	- 32	
Continuous Drain Currents	T _C = 125 °C	l _D	- 32	
Continuous Source Current (Diode Conduction) ^a		I _S	- 32	Α
Pulsed Drain Current ^b		I _{DM}	- 120	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	- 30	
Single Pulse Avalanche Energy	L = 0.1 min	E _{AS}	45	mJ
Maximum Power Dissipation ^b	T _C = 25 °C	P _D	83	W
Maximum Power Dissipation	$T_C = 125 ^{\circ}C$	VV		
$T_C = 125$ °C Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175	°C
Soldering Recommendations (Peak Tempera	ature) ^{e, f}		260	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount ^c	R_{thJA}	65	°C/W
Junction-to-Case (Drain)		R_{thJC}	1.8	C/VV

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Parametric verification ongoing.
- e. See Solder Profile (www.vishay.com/doc?73257). The PowerPAK SO-8L. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- f. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.



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PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static	<u>'</u>	•			ı		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0, I _D = - 250 μA	- 12	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = - 250 μA	- 0.45	- 0.6	- 1.5	V
Gate-Source Leakage	I _{GSS}	V _{DS} =	: 0 V, V _{GS} = ± 8 V	-	-	± 100	nA
		V _{GS} = 0 V	V _{DS} = - 12 V	-	-	- 1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	V _{DS} = - 12 V, T _J = 125 °C	-	-	- 50	μΑ
		V _{GS} = 0 V	V _{DS} = - 12 V, T _J = 175 °C	-	-	- 250	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = - 4.5 V	V _{DS} ≤ - 5 V	- 30	-	-	Α
		V _{GS} = - 4.5 V	I _D = - 15 A	-	0.0050	0.0060	
Drain Course On State Resistance		V _{GS} = - 4.5 V	I _D = - 15 A, T _J = 125 °C	-	-	0.0073	Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V	I _D = - 15 A, T _J = 175 °C	-	-	0.0080	
		V _{GS} = - 2.5 V	I _D = - 15 A	-	0.0065	0.0080	
Forward Transconductanceb	9 _{fs}	V _{DS} =	- 15 V, I _D = - 15 A	-	60	-	S
Dynamic ^b		•					
Input Capacitance	C _{iss}			-	8012	10 015	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	$V_{DS} = -6 V$, $f = 1 MHz$	-	3808	4760	pF
Reverse Transfer Capacitance	C _{rss}			-	3320	4150	
Total Gate Charge ^c	Qg			-	109	164	
Gate-Source Charge ^c	Q _{gs}	V _{GS} = - 4.5 V	$V_{DS} = -6 \text{ V}, I_{D} = -8.9 \text{ A}$	-	11	-	nC
Gate-Drain Charge ^c	Q _{gd}			-	29	-	
Gate Resistance	R _g		f = 1 MHz	1.8	3.7	5.6	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	43	65	
Rise Time ^c	t _r	V _{DD} :	= - 6 V, R _I = 6 Ω	-	63	95	1
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 1 Å, $V_{GEN} =$ - 4.5 V, $R_g =$ 1 Ω		263	395	ns	
Fall Time ^c	t _f			-	166	250	
Source-Drain Diode Ratings and Char-	acteristics ^b						
Pulsed Current ^a	I _{SM}			-	-	- 120	Α
Forward Voltage	V _{SD}	I _F = - 25 A, V _{GS} = 0		-	- 0.8	- 1.2	V

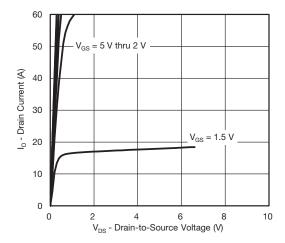
Notes

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

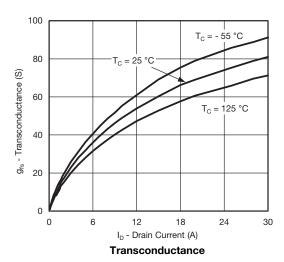
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

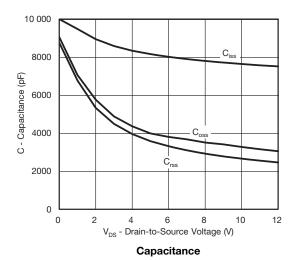


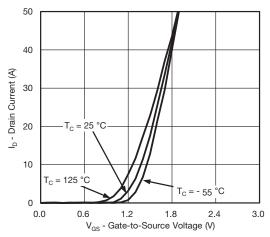
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



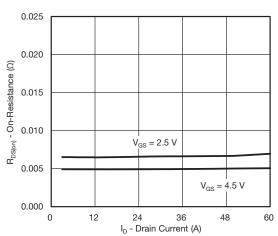
Output Characteristics



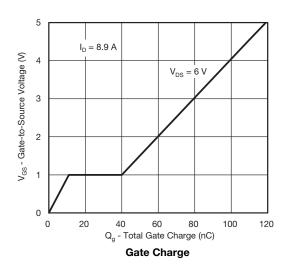




Transfer Characteristics

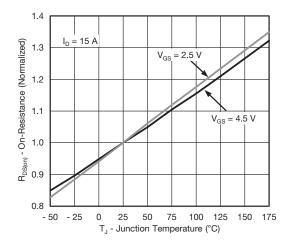


On-Resistance vs. Drain Current

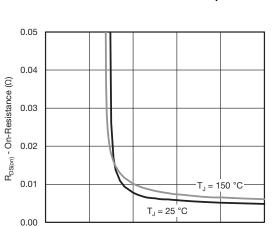




TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



On-Resistance vs. Junction Temperature



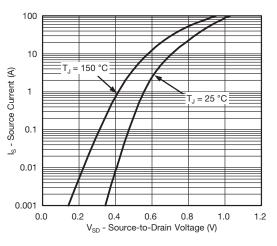
V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage

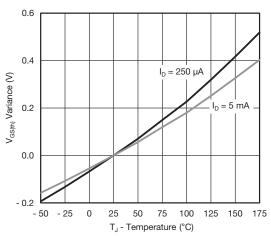
3

2

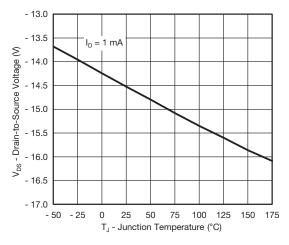
0



Source-Drain Diode Forward Voltage



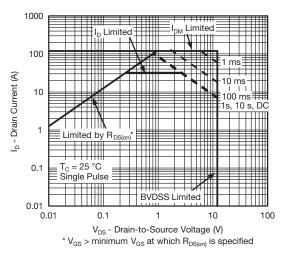
Threshold Voltage



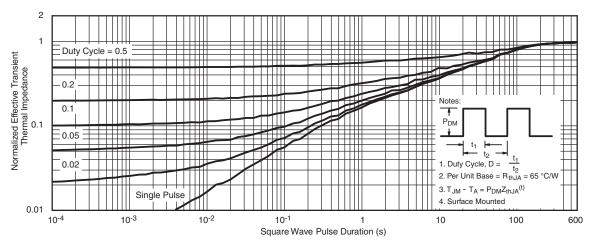
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



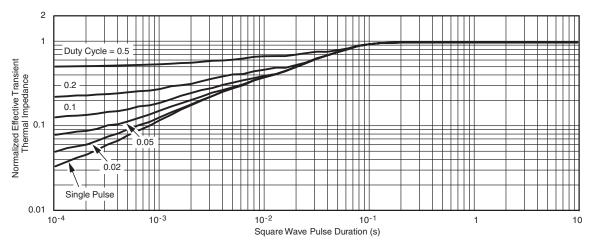
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

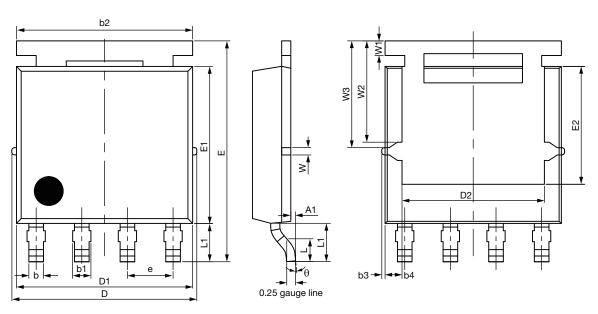
Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?67063.

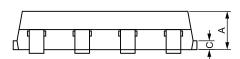


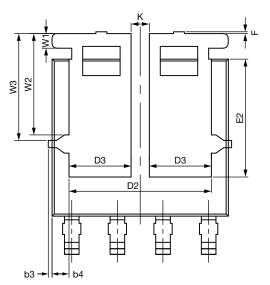
PowerPAK® SO-8L Case Outline 1



Topside view

Backside view (single)





Backside view (dual)



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DIM	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094	•		0.004		
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC	•	0.050 BSC			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	3.18	3.28	3.38	0.125	0.129	0.133	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
K		0.51		0.020			
W	0.23		0.009				
W1	0.41		0.016				
W2	2.82		0.111				
W3		2.96			0.117		
θ	0°	-	10°	0°	-	10°	

ECN: S19-0643-Rev. E, 05-Aug-2019

DWG: 5976

Note

• Millimeters will gover



RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)



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